# AVAGO TECHNOLOGIES, INC.

P.O. Box 1920 Denver, Colorado 80201-1920

### ATTORNEY DOCKET NO. 70030259-1

DEC 27 2005

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

entor(s): Kong Weng Lee et al.

Serial No.: 10/608,605

Examiner: Owens, Douglas W

Filing Date: June 27, 2003

Group Art Unit: 2811

Title: Packaging Device for Semiconductor Die, Semiconductor Device Incorporating Same

and Method of Making Same

COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria VA 22313-1450

#### TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT

		1100							
Si	r:								
Transmitted herewith is/are the following in the above-identified application:									
×	Response		Petition to extend time to respond						
×	New fee a		Supplemental Declaration						
No additional fee (Address envelope to "Mail Stop Amendments")									
Other: (Fee \$)									
- 1	CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY								
	(1) FOR	(2) CLAIMS REMAINING AFTER AMENDMENT	AIMS RÉMAINING NUMBER HIGHEST NUMBER			(5) (6) PRESENT RATE EXTRA		(7) ADDITIONAL FEES	
	TOTAL CLAIMS	21	MINUS	20		= 1	X 50	\$	50
	INDEP. CLAIMS	3	MINUS	3		= 0	X 200	\$	0
	☐ FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM + 360							\$	0
	EXTENSION FEE	EXTENSION 1 <sup>ST</sup> MONTH 2 <sup>ND</sup> MONT FEE 120.00 ☐ 450.00			TH 3 <sup>RD</sup> MONTH 4 <sup>TH</sup> ☐ 1020.00 ☐ 159			\$	0
	OTHER FEES							\$	0
	TOTAL ADDITIONAL FEE FOR THIS AMENDMENT							\$	50

Charge \$50\_\_ to Deposit Account **50-3718**. At any time during the pendency of this application, please charge any fees required or credit any over payment to Deposit Account **50-3718** pursuant to 37 CFR 1.2 5. Additionally please charge any fees to Deposit Account **50-3718** under 37 CFR 1.16, 1.17, 1.19, 1.20 and 1.21. A duplicate . copy of this transmittal letter is enclosed.

I hereby certify that this correspondence is being Deposited with the United States Postal Service as First class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-1450.

Date of Deposit: 12/23/2005

Typed Name: P. S. Dara

Signature: \_\_\_\_

Respectfully submitted,

Kong Weng Lee et al.

P. S. Dara

Attorney/Agent for Applicant(s)

Reg. No. 52,793

Date: 12/23/2005

Telephone No. (404) 610-5689

Rev 10/04 (TransAmd)



### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Confirmation No.: 2253

Kong Weng Lee

Group Art Unit: 2811

Serial No.: 10/608,605

Examiner: Owens, Douglas W

Filed: 6/27/2003

Docket No. 70030259-1

For: Packaging Device for Semiconductor Die, Semiconductor Device Incorporating Same and Method of Making Same

## **AMENDMENT AND RESPONSE**

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

The outstanding non-final Office Action mailed September 27, 2005 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

### **AUTHORIZATION TO DEBIT ACCOUNT**

It is not believed that extensions of time or fees for net addition of claims are required, beyond those that may otherwise be provided for in documents accompanying this paper. However, in the event that additional extensions of time are necessary to allow consideration of this paper, such extensions are hereby petitioned under 37 C.F.R. § 1.136(a), and any fees required therefor (including fees for net addition of claims) are hereby authorized to be charged to Avago deposit account no. 50-3718.

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